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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	1500
Total RAM Bits	18432
Number of I/O	67
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	100-LQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec1e-3t100c

Introduction

The LatticeECP/EC family of FPGA devices is optimized to deliver mainstream FPGA features at low cost. For maximum performance and value, the LatticeECP™ (Economy Plus) FPGA concept combines an efficient FPGA fabric with high-speed dedicated functions. Lattice's first family to implement this approach is the LatticeECP-DSP™ (Economy Plus DSP) family, providing dedicated high-performance DSP blocks on-chip. The LatticeEC™ (Economy) family supports all the general purpose features of LatticeECP devices without dedicated function blocks to achieve lower cost solutions.

The LatticeECP/EC FPGA fabric, which was designed from the outset with low cost in mind, contains all the critical FPGA elements: LUT-based logic, distributed and embedded memory, PLLs and support for mainstream I/Os. Dedicated DDR memory interface logic is also included to support this memory that is becoming increasingly prevalent in cost-sensitive applications.

The ispLEVER® design tool suite from Lattice allows large complex designs to be efficiently implemented using the LatticeECP/EC FPGA family. Synthesis library support for LatticeECP/EC is available for popular logic synthesis tools. The ispLEVER tool uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP/EC device. The ispLEVER tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-designed IP (Intellectual Property) ispLeverCORE™ modules for the LatticeECP/EC family. By using these IPs as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Architecture Overview

The LatticeECP-DSP and LatticeEC architectures contain an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM Embedded Block RAM (EBR), as shown in Figures 2-1 and 2-2. In addition, LatticeECP-DSP supports an additional row of DSP blocks, as shown in Figure 2-2.

There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional unit without RAM/ROM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM, ROM and register functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row. The PFU blocks are used on the outside rows. The rest of the core consists of rows of PFF blocks interspersed with rows of PFU blocks. For every three rows of PFF blocks there is a row of PFU blocks.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysI/O interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. sysMEM EBRs are large dedicated fast memory blocks. They can be configured as RAM or ROM.

The PFU, PFF, PIC and EBR Blocks are arranged in a two-dimensional grid with rows and columns as shown in Figure 2-1. The blocks are connected with many vertical and horizontal routing channel resources. The place and route software tool automatically allocates these routing resources.

At the end of the rows containing the sysMEM Blocks are the sysCLOCK Phase Locked Loop (PLL) Blocks. These PLLs have multiply, divide and phase shifting capability; they are used to manage the phase relationship of the clocks. The LatticeECP/EC architecture provides up to four PLLs per device.

Every device in the family has a JTAG Port with internal Logic Analyzer (ispTRACY) capability. The sysCONFIG™ port which allows for serial or parallel device configuration. The LatticeECP/EC devices use 1.2V as their core voltage.

Routing

There are many resources provided in the LatticeECP/EC devices to route signals individually or as busses with related control signals. The routing resources consist of switching circuitry, buffers and metal interconnect (routing) segments.

The inter-PFU connections are made with x1 (spans two PFU), x2 (spans three PFU) and x6 (spans seven PFU). The x1 and x2 connections provide fast and efficient connections in horizontal and vertical directions. The x2 and x6 resources are buffered, the routing of both short and long connections between PFUs.

The ispLEVER design tool suite takes the output of the synthesis tool and places and routes the design. Generally, the place and route tool is completely automatic, although an interactive routing editor is available to optimize the design.

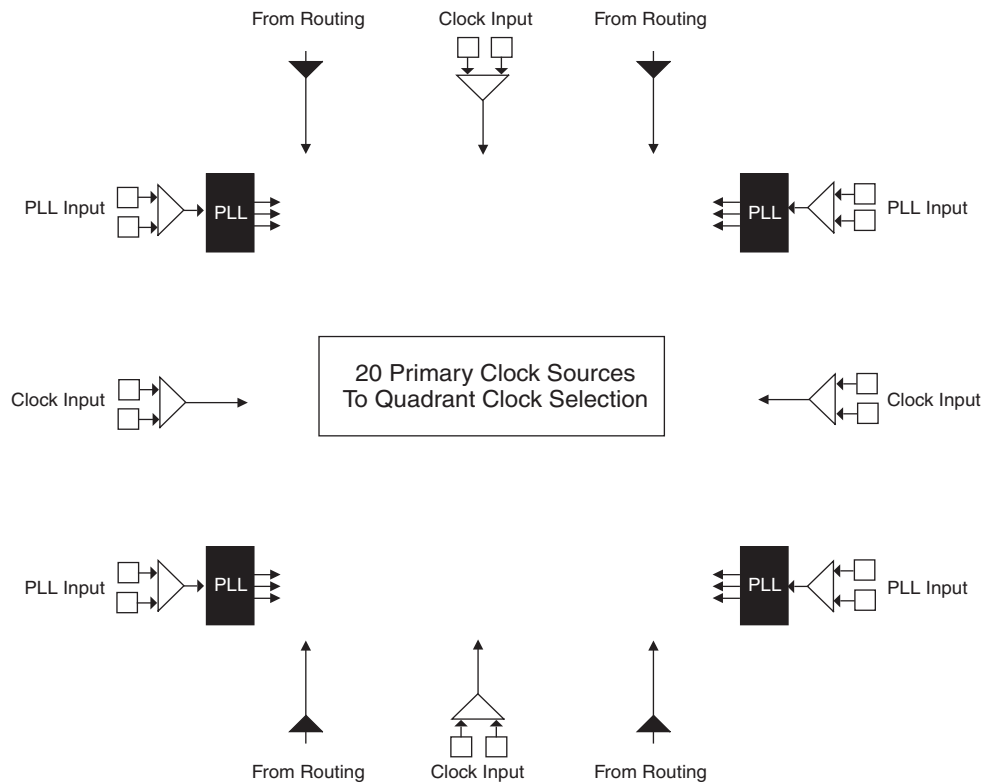
Clock Distribution Network

The clock inputs are selected from external I/O, the sysCLOCK™ PLLs or routing. These clock inputs are fed through the chip via a clock distribution system.

Primary Clock Sources

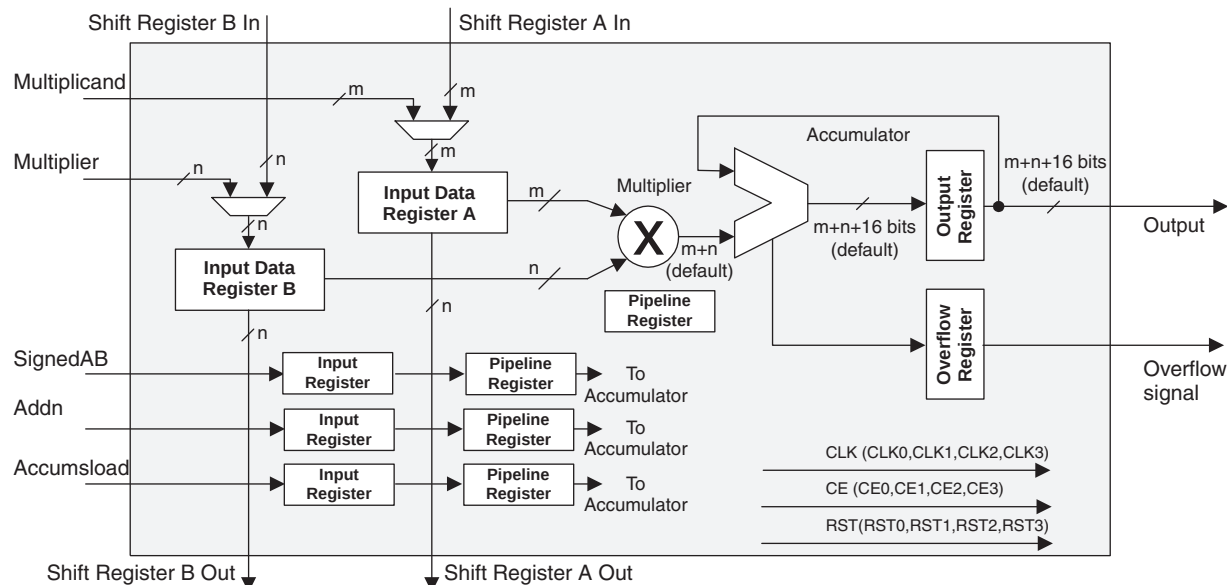
LatticeECP/EC devices derive clocks from three primary sources: PLL outputs, dedicated clock inputs and routing. LatticeECP/EC devices have two to four sysCLOCK PLLs, located on the left and right sides of the device. There are four dedicated clock inputs, one on each side of the device. Figure 2-6 shows the 20 primary clock sources.

Figure 2-6. Primary Clock Sources



Note: Smaller devices have two PLLs.

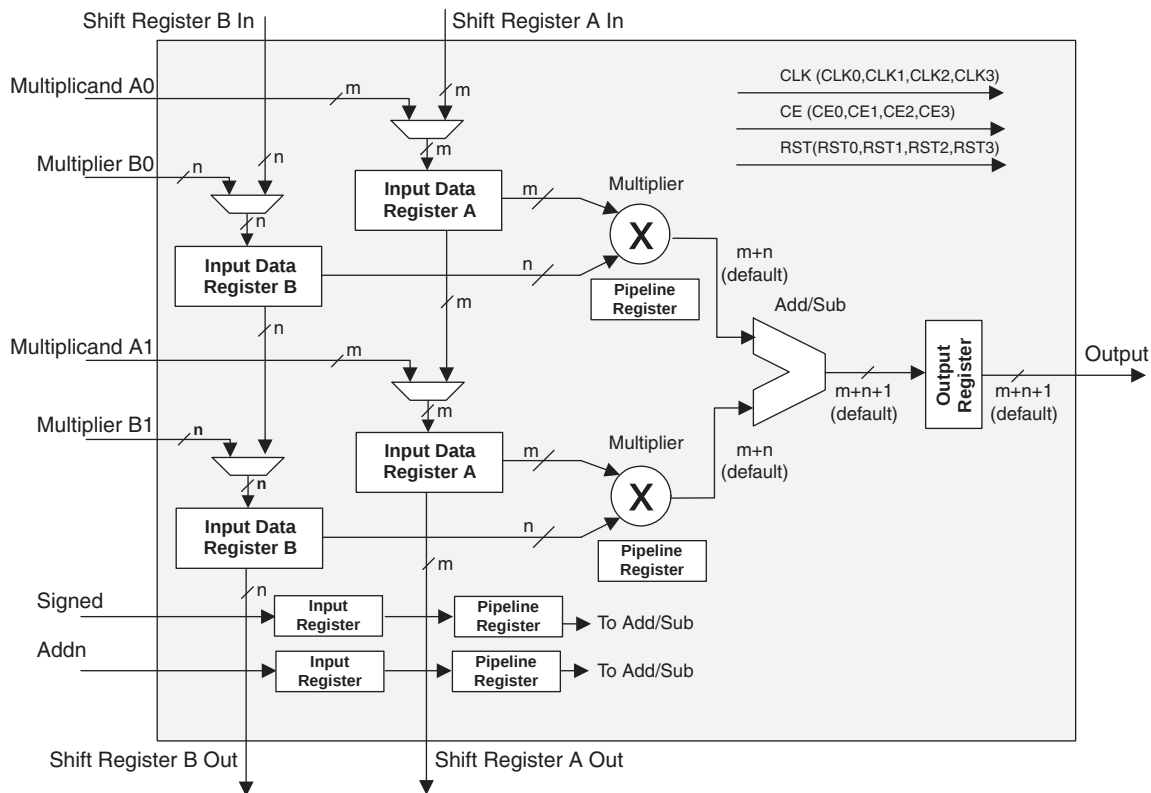
Figure 2-20. MAC sysDSP Element



MULTADD sysDSP Element

In this case, the operands A0 and B0 are multiplied and the result is added/subtracted with the result of the multiplier operation of operands A1 and A2. The user can enable the input, output and pipeline registers. Figure 2-21 shows the MULTADD sysDSP element.

Figure 2-21. MULTADD



Signed and Unsigned with Different Widths

The DSP block supports different widths of signed and unsigned multipliers besides x9, x18 and x36 widths. For unsigned operands, unused upper data bits should be filled to create a valid x9, x18 or x36 operand. For signed two's complement operands, sign extension of the most significant bit should be performed until x9, x18 or x36 width is reached. Table 2-8 provides an example of this.

Table 2-8. An Example of Sign Extension

Number	Unsigned	Unsigned 9-bit	Unsigned 18-bit	Signed	Two's Complement Signed 9-Bits	Two's Complement Signed 18-bits
+5	0101	000000101	000000000000000101	0101	000000101	000000000000000101
-6	0110	000000110	000000000000000110	1010	111111010	111111111111111010

OVERFLOW Flag from MAC

The sysDSP block provides an overflow output to indicate that the accumulator has overflowed. When two unsigned numbers are added and the result is a smaller number then accumulator roll over is said to occur and overflow signal is indicated. When two positive numbers are added with a negative sum and when two negative numbers are added with a positive sum, then the accumulator “roll-over” is said to have occurred and an overflow signal is indicated. Note when overflow occurs the overflow flag is present for only one cycle. By counting these overflow pulses in FPGA logic, larger accumulators can be constructed. The conditions overflow signals for signed and unsigned operands are listed in Figure 2-23.

Figure 2-23. Accumulator Overflow/Underflow Conditions

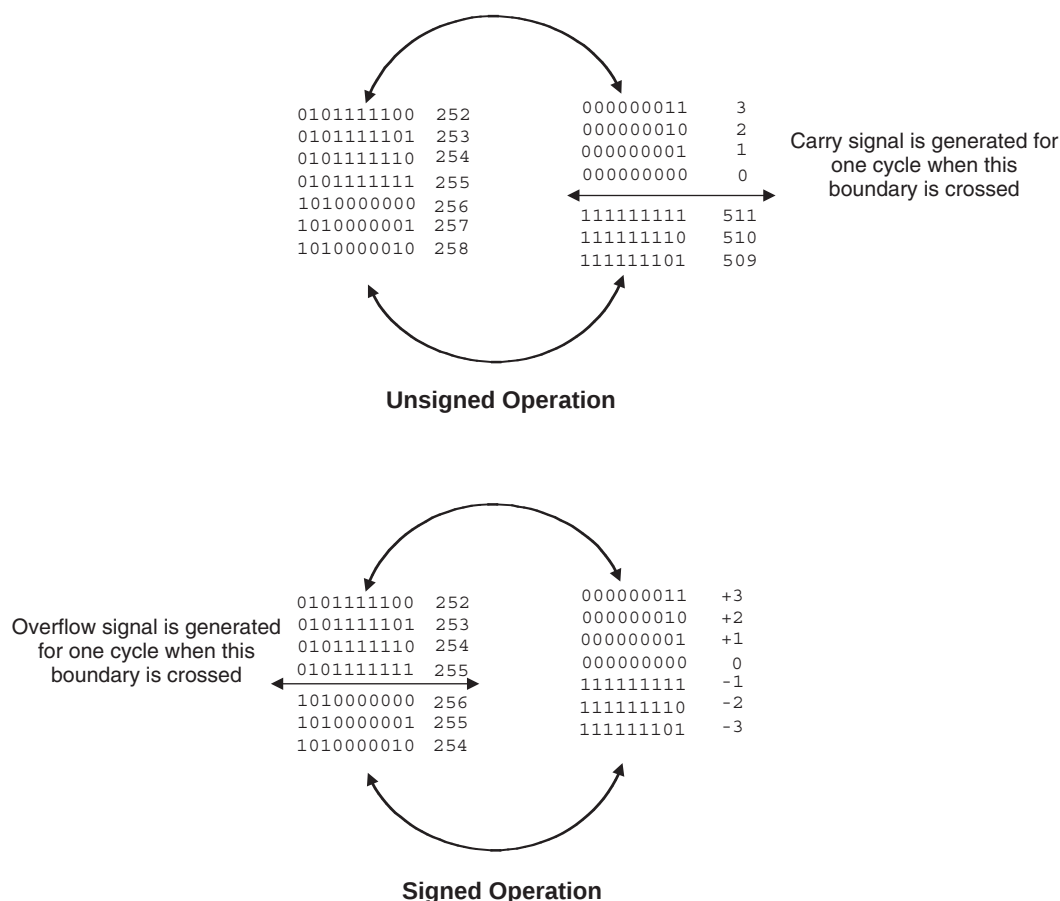


Figure 2-32. DQS Local Bus.

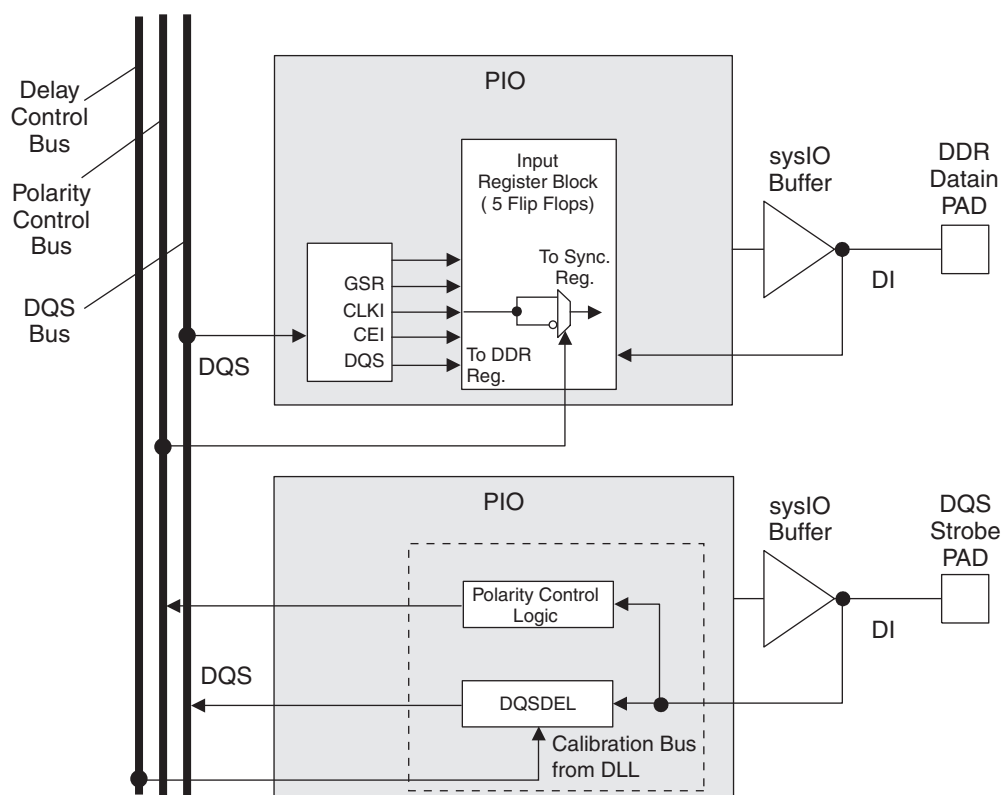
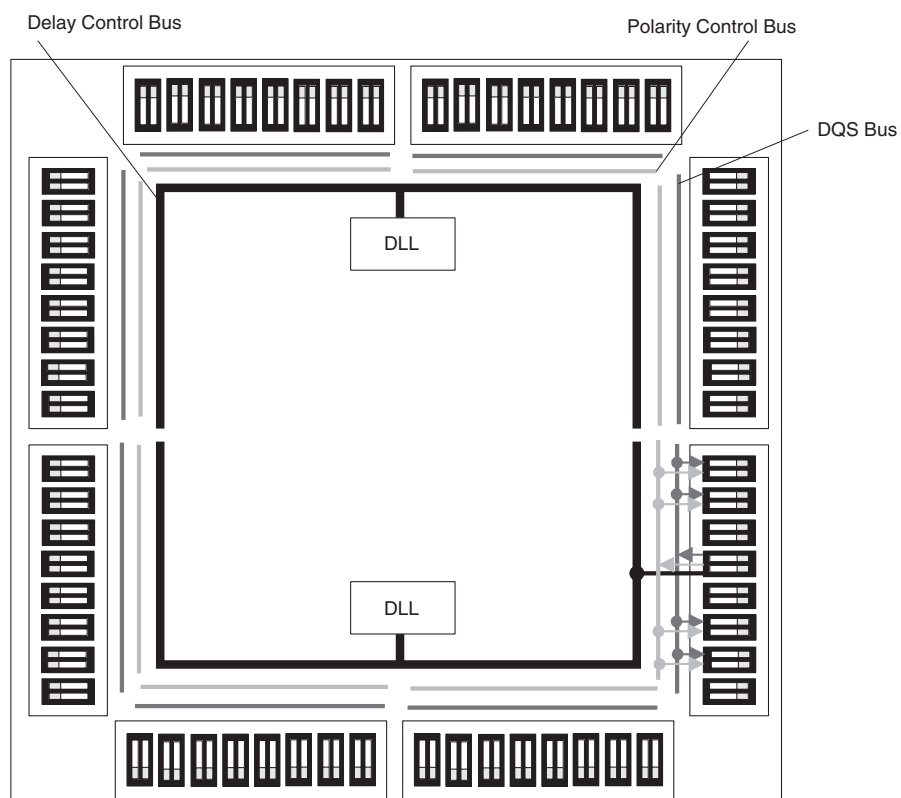


Figure 2-33. DLL Calibration Bus and DQS/DQS Transition Distribution



be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP/EC devices contain two possible ports that can be used for device configuration. The test access port (TAP), which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration.

The TAP supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins (please refer to TN1053 for more information about using the dual-use pins as general purpose I/O). There are four configuration options for LatticeECP/EC devices:

1. Industry standard SPI memories.
2. Industry standard byte wide flash and ispMACH 4000 for control/addressing.
3. Configuration from system microprocessor via the configuration bus or TAP.
4. Industry standard FPGA board memory.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next power-up sequence.

For more information about device configuration, please see the list of technical documentation at the end of this data sheet.

Internal Logic Analyzer Capability (ispTRACY)

All LatticeECP/EC devices support an internal logic analyzer diagnostic feature. The diagnostic features provide capabilities similar to an external logic analyzer, such as programmable event and trigger condition and deep trace memory. This feature is enabled by Lattice's ispTRACY. The ispTRACY utility is added into the user design at compile time.

For more information about ispTRACY, please see information regarding additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP/EC devices require a single external, 10K ohm +/- 1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

DC Electrical Characteristics

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{IL}, I_{IH}^1	Input or I/O Leakage	$0 \leq V_{IN} \leq (V_{CCIO} - 0.2V)$	—	—	10	μA
$I_{IH}^{1,3}$	Input or I/O High Leakage	$(V_{CCIO} - 0.2V) \leq V_{IH} \leq 3.6V$	—	—	40	μA
I_{PU}	I/O Active Pull-up Current	$0 \leq V_{IN} \leq 0.7 V_{CCIO}$	-30	—	-150	μA
I_{PD}	I/O Active Pull-down Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MAX)$	30	—	150	μA
I_{BHLS}	Bus Hold Low sustaining current	$V_{IN} = V_{IL} (MAX)$	30	—	—	μA
I_{BHHS}	Bus Hold High sustaining current	$V_{IN} = 0.7V_{CCIO}$	-30	—	—	μA
I_{BHLO}	Bus Hold Low Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	150	μA
I_{BHLH}	Bus Hold High Overdrive current	$0 \leq V_{IN} \leq V_{IH} (MAX)$	—	—	-150	μA
V_{BHT}	Bus Hold trip Points	$0 \leq V_{IN} \leq V_{IH} (MAX)$	$V_{IL} (MAX)$	—	$V_{IH} (MIN)$	V
C1	I/O Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	8	—	pf
C2	Dedicated Input Capacitance ²	$V_{CCIO} = 3.3V, 2.5V, 1.8V, 1.5V, 1.2V,$ $V_{CC} = 1.2V, V_{IO} = 0 \text{ to } V_{IH} (MAX)$	—	6	—	pf

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tri-stated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. T_A 25°C, $f = 1.0MHz$

3. For top and bottom general purpose I/O pins, when V_{IH} is higher than V_{CCIO} , a transient current typically of 30ns in duration or less with a peak current of 6mA can occur on the high-to-low transition. For left and right I/O banks, V_{IH} must be less than or equal to V_{CCIO} .

Supply Current (Standby)^{1, 2, 3, 4}

Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	LFEC1	6	mA
		LFEC3	10	mA
		LFEC6/LFEC6	15	mA
		LFEC10/LFEC10	25	mA
		LFEC15/LFEC15	35	mA
		LFEC20/LFEC20	60	mA
		LFEC33/LFEC33	85	mA
I_{CCAUX}	Auxiliary Power Supply Current		15	mA
I_{CCPLL}	PLL Power Supply Current		5	mA
I_{CCIO}	Bank Power Supply Current ⁶		2	mA
I_{CCJ}	V_{CCJ} Power Supply Current		5	mA

1. For further information about supply current, please see the list of technical documentation at the end of this data sheet.
2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
3. Frequency 0MHz.
4. Pattern represents a "blank" configuration data file.
5. $T_J=25^{\circ}\text{C}$, power supplies at nominal voltage.
6. Per bank.

sysI/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}^1 (mA)	I_{OH}^1 (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVTTTL	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.8	-0.3	$0.35V_{CCIO}$	$0.65V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	16, 12, 8, 4	-16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.5	-0.3	$0.35V_{CCIO}$	$0.65V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	8, 4	-8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.2	-0.3	$0.35V_{CC}$	$0.65V_{CC}$	3.6	0.4	$V_{CCIO} - 0.4$	6, 2	-6, -2
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
PCI	-0.3	$0.3V_{CCIO}$	$0.5V_{CCIO}$	3.6	$0.1V_{CCIO}$	$0.9V_{CCIO}$	1.5	-0.5
SSTL3 class I	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.7	$V_{CCIO} - 1.1$	8	-8
SSTL3 class II	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.5	$V_{CCIO} - 0.9$	16	-16
SSTL2 class I	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.54	$V_{CCIO} - 0.62$	7.6	-7.6
SSTL2 class II	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.35	$V_{CCIO} - 0.43$	15.2	-15.2
SSTL18 class I	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.4	$V_{CCIO} - 0.4$	6.7	-6.7
HSTL15 class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	8	-8
HSTL15 class III	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	24	-8
HSTL18 class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	9.6	-9.6
HSTL18 class II	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	16	-16
HSTL18 class III	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	24	-8

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed $n * 8\text{mA}$. Where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

Pin Information Summary

		LFEC1			LFEC3				LFEC6/EC6				LFEC6/EC10		
Pin Type		100-TQFP	144-TQFP	208-PQFP	100-TQFP	144-TQFP	208-PQFP	256-fpBGA	144-TQFP	208-PQFP	256-fpBGA	484-fpBGA	208-PQFP	256-fpBGA	484-fpBGA
Single Ended User I/O		67	97	112	67	97	145	160	97	147	195	224	147	195	288
Differential Pair User I/O		29	46	56	29	46	72	80	46	72	97	112	72	97	144
Configu-ration	Dedicated	13	13	13	13	13	13	13	13	13	13	13	13	13	13
	Muxed	48	48	48	48	48	48	48	48	48	48	48	56	56	56
TAP		5	5	5	5	5	5	5	5	5	5	5	5	5	5
Dedicated (total without supplies)		80	110	160	80	110	160	208	110	160	208	373	160	208	373
V _{CC}		2	3	3	2	3	3	10	4	4	10	20	6	10	20
V _{CCAUX}		2	2	2	4	4	4	4	2	4	2	12	4	2	12
V _{CCPLL}		0	0	0	0	0	0	0	0	0	0	0	0	0	0
V _{CCIO}	Bank0	1	2	2	1	2	3	2	2	3	2	4	3	2	4
	Bank1	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank2	1	1	1	2	2	2	2	1	2	2	4	2	2	4
	Bank3	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank4	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank5	1	2	2	1	2	2	2	2	3	2	4	3	2	4
	Bank6	1	2	2	1	2	2	2	2	2	2	4	2	2	4
	Bank7	1	1	1	2	2	2	2	1	2	2	4	2	2	4
GND, GND0-GND7		8	13	13	8	13	16	20	14	18	20	44	20	20	44
NC		0	2	51	0	2	9	35	0	4	0	139	0	0	75
Single Ended/Differential I/O Pair per Bank	Bank 0	11/5	14/7	16/8	11/5	14/7	26/13	32/16	14/7	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 1	11/5	13/6	16/8	11/5	13/6	16/8	16/8	13/6	17/8	18/9	32/16	17/8	18/9	32/16
	Bank 2	3/1	8/4	8/4	3/1	8/4	14/7	16/8	8/4	14/7	16/8	16/8	14/7	16/8	32/16
	Bank 3	8/4	13/6	16/8	8/4	13/6	16/8	16/8	13/6	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 4	12/4	14/6	16/8	12/4	14/6	16/8	16/8	14/6	17/8	17/8	32/16	17/8	17/8	32/16
	Bank 5	9/4	13/6	16/8	9/4	13/6	26/13	32/16	13/6	26/13	32/16	32/16	26/13	32/16	48/24
	Bank 6	5/2	14/7	16/8	5/2	14/7	16/8	16/8	14/7	16/8	32/16	32/16	16/8	32/16	32/16
	Bank 7	8/4	8/4	8/4	8/4	8/4	15/7	16/8	8/4	15/7	16/8	16/8	15/7	16/8	32/16
V _{CCJ}		1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.

LFEC1, LFEC3, LFEC6/EC6 Logic Signal Connections: 144 TQFP (Cont.)

Pin Number	LFEC1				LFEC3				LFEC6/EC6			
	Pin Function	Bank	LVD S	Dual Function	Pin Function	Bank	LVD S	Dual Function	Pin Function	Bank	LVD S	Dual Function
99	VCC	-			VCC	-			VCC	-		
100	PR5B	2	C	PCLKC2_0	PR9B	2	C	PCLKC2_0	PR9B	2	C	PCLKC2_0
101	PR5A	2	T	PCLKT2_0	PR9A	2	T	PCLKT2_0	PR9A	2	T	PCLKT2_0
102	PR4B	2	C		PR8B	2	C		PR8B	2	C	
103	PR4A	2	T		PR8A	2	T		PR8A	2	T	
104	PR3B	2	C		PR7B	2	C		PR7B	2	C	
105	PR3A	2	T		PR7A	2	T		PR7A	2	T	
106	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2
107	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2
108	VCCIO2	2			VCCIO2	2			VCCIO2	2		
109*	GND1 GND2	-			GND1 GND2	-			GND1 GND2	-		
110	VCCIO1	1			VCCIO1	1			VCCIO1	1		
111	PT17B	1	C		PT25B	1	C		PT25B	1	C	
112	PT17A	1	T		PT25A	1	T		PT25A	1	T	
113	PT15A	1			PT23A	1			PT23A	1		
114	PT14B	1	C		PT22B	1	C		PT22B	1	C	
115	PT14A	1	T	TDQS14	PT22A	1	T	TDQS22	PT22A	1	T	TDQS22
116	PT13B	1	C		PT21B	1	C		PT21B	1	C	
117	GND1	1			GND1	1			GND1	1		
118	PT13A	1	T		PT21A	1	T		PT21A	1	T	
119	PT12B	1	C		PT20B	1	C		PT20B	1	C	
120	PT12A	1	T		PT20A	1	T		PT20A	1	T	
121	PT11B	1	C	VREF2_1	PT19B	1	C	VREF2_1	PT19B	1	C	VREF2_1
122	PT11A	1	T	VREF1_1	PT19A	1	T	VREF1_1	PT19A	1	T	VREF1_1
123	PT10B	1	C		PT18B	1	C		PT18B	1	C	
124	PT10A	1	T		PT18A	1	T		PT18A	1	T	
125	VCCIO1	1			VCCIO1	1			VCCIO1	1		
126	VCCAUX	-			VCCAUX	-			VCCAUX	-		
127	PT9B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0
128	GND0	0			GND0	0			GND0	0		
129	PT9A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0
130	PT8B	0	C	VREF1_0	PT16B	0	C	VREF1_0	PT16B	0	C	VREF1_0
131	PT8A	0	T	VREF2_0	PT16A	0	T	VREF2_0	PT16A	0	T	VREF2_0
132	PT7B	0	C		PT15B	0	C		PT15B	0	C	
133	PT7A	0	T		PT15A	0	T		PT15A	0	T	
134	PT6B	0	C		PT14B	0	C		PT14B	0	C	
135	PT6A	0	T	TDQS6	PT14A	0	T	TDQS14	PT14A	0	T	TDQS14
136	VCCIO0	0			VCCIO0	0			VCCIO0	0		
137	PT5B	0	C		PT13B	0	C		PT13B	0	C	
138	PT5A	0	T		PT13A	0	T		PT13A	0	T	
139	PT4B	0	C		PT12B	0	C		PT12B	0	C	
140	PT4A	0	T		PT12A	0	T		PT12A	0	T	
141	PT2B	0	C		PT10B	0	C		PT10B	0	C	
142	PT2A	0	T		PT10A	0	T		PT10A	0	T	
143	VCCIO0	0			VCCIO0	0			VCCIO0	0		
144*	GND0 GND7	-			GND0 GND7	-			GND0 GND7	-		

*Double bonded to the pin.

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
43	PL11A	6	T	LDQS11	PL15A	6	T	LDQS15
44	PL11B	6	C		PL15B	6	C	
45	PL12A	6	T		PL16A	6	T	
46	PL12B	6	C		PL16B	6	C	
47	PL13A	6	T		PL17A	6	T	
48	PL13B	6	C		PL17B	6	C	
49	PL14A	6	T	VREF1_6	PL18A	6	T	VREF1_6
50	PL14B	6	C	VREF2_6	PL18B	6	C	VREF2_6
51	VCCIO6	6			VCCIO6	6		
52*	GND5 GND6	-			GND5 GND6	-		
53	VCCIO5	5			VCCIO5	5		
54	NC	-			PB2A	5	T	
55	NC	-			PB2B	5	C	
56	NC	-			PB3A	5	T	
57	NC	-			PB3B	5	C	
58	NC	-			PB4A	5	T	
59	NC	-			PB4B	5	C	
60	NC	-			PB5A	5	T	
61	NC	-			PB5B	5	C	
62	NC	-			PB6A	5	T	BDQS6
63	NC	-			PB6B	5	C	
64	NC	-			VCCIO5	5		
65	PB2A	5	T		PB10A	5	T	
66	PB2B	5	C		PB10B	5	C	
67	PB3A	5	T		PB11A	5	T	
68	PB3B	5	C		PB11B	5	C	
69	PB4A	5	T		PB12A	5	T	
70	PB4B	5	C		PB12B	5	C	
71	PB5A	5	T		PB13A	5	T	
72	NC	-			GND5	5		
73	PB5B	5	C		PB13B	5	C	
74	VCCIO5	5			VCCIO5	5		
75	PB6A	5	T	BDQS6	PB14A	5	T	BDQS14
76	PB6B	5	C		PB14B	5	C	
77	PB7A	5	T		PB15A	5	T	
78	PB7B	5	C		PB15B	5	C	
79	PB8A	5	T	VREF2_5	PB16A	5	T	VREF2_5
80	PB8B	5	C	VREF1_5	PB16B	5	C	VREF1_5
81	PB9A	5	T	PCLKT5_0	PB17A	5	T	PCLKT5_0
82	GND5	5			GND5	5		
83	PB9B	5	C	PCLKC5_0	PB17B	5	C	PCLKC5_0
84	VCCAUX	-			VCCAUX	-		

LFEC6P/EC6, LFEC6P/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC6P/EC6				LFEC6P/EC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
43	PL24A	6	T	LDQS24	PL33A	6	T	LDQS33
44	PL24B	6	C		PL33B	6	C	
45	PL25A	6	T		PL34A	6	T	
46	PL25B	6	C		PL34B	6	C	
47	PL26A	6	T		PL35A	6	T	
48	PL26B	6	C		PL35B	6	C	
49	PL27A	6	T	VREF1_6	PL36A	6	T	VREF1_6
50	PL27B	6	C	VREF2_6	PL36B	6	C	VREF2_6
51	VCCIO6	6			VCCIO6	6		
52*	GND5 GND6	-			GND5 GND6	-		
53	VCCIO5	5			VCCIO5	5		
54	PB2A	5	T		PB2A	5	T	
55	PB2B	5	C		PB2B	5	C	
56	PB3A	5	T		PB3A	5	T	
57	PB3B	5	C		PB3B	5	C	
58	PB4A	5	T		PB4A	5	T	
59	PB4B	5	C		PB4B	5	C	
60	PB5A	5	T		PB5A	5	T	
61	PB5B	5	C		PB5B	5	C	
62	PB6A	5	T	BDQS6	PB6A	5	T	BDQS6
63	PB6B	5	C		PB6B	5	C	
64	VCCIO5	5			VCCIO5	5		
65	PB10A	5	T		PB18A	5	T	
66	PB10B	5	C		PB18B	5	C	
67	PB11A	5	T		PB19A	5	T	
68	PB11B	5	C		PB19B	5	C	
69	PB12A	5	T		PB20A	5	T	
70	PB12B	5	C		PB20B	5	C	
71	PB13A	5	T		PB21A	5	T	
72	GND5	5			GND5	5		
73	PB13B	5	C		PB21B	5	C	
74	VCCIO5	5			VCCIO5	5		
75	PB14A	5	T	BDQS14	PB22A	5	T	BDQS22
76	PB14B	5	C		PB22B	5	C	
77	PB15A	5	T		PB23A	5	T	
78	PB15B	5	C		PB23B	5	C	
79	PB16A	5	T	VREF2_5	PB24A	5	T	VREF2_5
80	PB16B	5	C	VREF1_5	PB24B	5	C	VREF1_5
81	PB17A	5	T	PCLKT5_0	PB25A	5	T	PCLKT5_0
82	GND5	5			GND5	5		
83	PB17B	5	C	PCLKC5_0	PB25B	5	C	PCLKC5_0
84	VCCAUX	-			VCCAUX	-		

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
E5	VCC	-			VCC	-		
E8	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M5	VCC	-			VCC	-		
M9	VCC	-			VCC	-		
B15	VCCAUX	-			VCCAUX	-		
R2	VCCAUX	-			VCCAUX	-		
F7	VCCIO0	0			VCCIO0	0		
F8	VCCIO0	0			VCCIO0	0		
F10	VCCIO1	1			VCCIO1	1		
F9	VCCIO1	1			VCCIO1	1		
G11	VCCIO2	2			VCCIO2	2		
H11	VCCIO2	2			VCCIO2	2		
J11	VCCIO3	3			VCCIO3	3		
K11	VCCIO3	3			VCCIO3	3		
L10	VCCIO4	4			VCCIO4	4		
L9	VCCIO4	4			VCCIO4	4		
L7	VCCIO5	5			VCCIO5	5		
L8	VCCIO5	5			VCCIO5	5		
J6	VCCIO6	6			VCCIO6	6		
K6	VCCIO6	6			VCCIO6	6		
G6	VCCIO7	7			VCCIO7	7		
H6	VCCIO7	7			VCCIO7	7		
F6	VCC	-			VCC	-		
F11	VCC	-			VCC	-		
L11	VCC	-			VCC	-		
L6	VCC	-			VCC	-		

LFEC/EC10 and LFEC/EC15 Logic Signal Connections: 256 fpBGA

Ball Number	LFEC10/LFEC10				LFEC15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND7	7		
D4	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
D3	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
GND	GND7	7			GND7	7		
C3	PL12A	7	T		PL16A	7	T	
C2	PL12B	7	C		PL16B	7	C	
B1	PL13A	7	T		PL17A	7	T	
C1	PL13B	7	C		PL17B	7	C	
E3	PL14A	7	T		PL18A	7	T	
GND	GND7	7			GND7	7		
-	-	-			GND7	7		
E4	PL14B	7	C		PL18B	7	C	
F4	PL15A	7	T	LDQS15	PL19A	7	T	LDQS19
F5	PL15B	7	C		PL19B	7	C	
G4	PL16A	7	T		PL20A	7	T	
G3	PL16B	7	C		PL20B	7	C	
D2	PL17A	7	T		PL21A	7	T	
D1	PL17B	7	C		PL21B	7	C	
E1	PL18A	7	T	PCLKT7_0	PL22A	7	T	PCLKT7_0
GND	GND7	7			GND7	7		
E2	PL18B	7	C	PCLKC7_0	PL22B	7	C	PCLKC7_0
F3	XRES	6			XRES	6		
G5	PL20A	6	T		PL24A	6	T	
H5	PL20B	6	C		PL24B	6	C	
F2	PL21A	6	T		PL25A	6	T	
F1	PL21B	6	C		PL25B	6	C	
H4	PL22A	6	T		PL26A	6	T	
H3	PL22B	6	C		PL26B	6	C	
G2	PL23A	6	T		PL27A	6	T	
GND	GND6	6			GND6	6		
G1	PL23B	6	C		PL27B	6	C	
J4	PL24A	6	T	LDQS24	PL28A	6	T	LDQS28
J3	PL24B	6	C		PL28B	6	C	
J5	PL25A	6	T		PL29A	6	T	
K5	PL25B	6	C		PL29B	6	C	
H2	PL26A	6	T		PL30A	6	T	
H1	PL26B	6	C		PL30B	6	C	
J2	PL27A	6	T		PL31A	6	T	
GND	GND6	6			GND6	6		
J1	PL27B	6	C		PL31B	6	C	
K4	TCK	6			TCK	6		
K3	TDI	6			TDI	6		

LFEC6/EC6, LFEC6/EC10, LFEC6/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC6/LFEC6					LFEC10/LFEC10					LFEC6/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
V12	PB16B	5	C	VREF1_5	V12	PB24B	5	C	VREF1_5	V12	PB24B	5	C	VREF1_5
AB10	PB17A	5	T	PCLKT5_0	AB10	PB25A	5	T	PCLKT5_0	AB10	PB25A	5	T	PCLKT5_0
GND	GND5	5			GND	GND5	5			GND	GND5	5		
AB11	PB17B	5	C	PCLKC5_0	AB11	PB25B	5	C	PCLKC5_0	AB11	PB25B	5	C	PCLKC5_0
Y12	PB18A	4	T	WRITEN	Y12	PB26A	4	T	WRITEN	Y12	PB26A	4	T	WRITEN
U11	PB18B	4	C	CS1N	U11	PB26B	4	C	CS1N	U11	PB26B	4	C	CS1N
W12	PB19A	4	T	VREF1_4	W12	PB27A	4	T	VREF1_4	W12	PB27A	4	T	VREF1_4
U12	PB19B	4	C	CSN	U12	PB27B	4	C	CSN	U12	PB27B	4	C	CSN
W13	PB20A	4	T	VREF2_4	W13	PB28A	4	T	VREF2_4	W13	PB28A	4	T	VREF2_4
U13	PB20B	4	C	D0/SPID7	U13	PB28B	4	C	D0/SPID7	U13	PB28B	4	C	D0/SPID7
AA12	PB21A	4	T	D2/SPID5	AA12	PB29A	4	T	D2/SPID5	AA12	PB29A	4	T	D2/SPID5
GND	GND4	4			GND	GND4	4			GND	GND4	4		
AB12	PB21B	4	C	D1/SPID6	AB12	PB29B	4	C	D1/SPID6	AB12	PB29B	4	C	D1/SPID6
T13	PB22A	4	T	BDQS22	T13	PB30A	4	T	BDQS30	T13	PB30A	4	T	BDQS30
V13	PB22B	4	C	D3/SPID4	V13	PB30B	4	C	D3/SPID4	V13	PB30B	4	C	D3/SPID4
W14	PB23A	4	T		W14	PB31A	4	T		W14	PB31A	4	T	
U14	PB23B	4	C	D4/SPID3	U14	PB31B	4	C	D4/SPID3	U14	PB31B	4	C	D4/SPID3
Y13	PB24A	4	T		Y13	PB32A	4	T		Y13	PB32A	4	T	
V14	PB24B	4	C	D5/SPID2	V14	PB32B	4	C	D5/SPID2	V14	PB32B	4	C	D5/SPID2
AA13	PB25A	4	T		AA13	PB33A	4	T		AA13	PB33A	4	T	
GND	GND4	4			GND	GND4	4			GND	GND4	4		
AB13	PB25B	4	C	D6/SPID1	AB13	PB33B	4	C	D6/SPID1	AB13	PB33B	4	C	D6/SPID1
AA14	PB26A	4	T		AA14	PB34A	4	T		AA14	PB34A	4	T	
Y14	PB26B	4	C		Y14	PB34B	4	C		Y14	PB34B	4	C	
Y15	PB27A	4	T		Y15	PB35A	4	T		Y15	PB35A	4	T	
W15	PB27B	4	C		W15	PB35B	4	C		W15	PB35B	4	C	
V15	PB28A	4	T		V15	PB36A	4	T		V15	PB36A	4	T	
T14	PB28B	4	C		T14	PB36B	4	C		T14	PB36B	4	C	
AB14	PB29A	4	T		AB14	PB37A	4	T		AB14	PB37A	4	T	
GND	GND4	4			GND	GND4	4			GND	GND4	4		
AB15	PB29B	4	C		AB15	PB37B	4	C		AB15	PB37B	4	C	
AB16	PB30A	4	T	BDQS30	AB16	PB38A	4	T	BDQS38	AB16	PB38A	4	T	BDQS38
AA15	PB30B	4	C		AA15	PB38B	4	C		AA15	PB38B	4	C	
AB17	PB31A	4	T		AB17	PB39A	4	T		AB17	PB39A	4	T	
AA16	PB31B	4	C		AA16	PB39B	4	C		AA16	PB39B	4	C	
AB18	PB32A	4	T		AB18	PB40A	4	T		AB18	PB40A	4	T	
AA17	PB32B	4	C		AA17	PB40B	4	C		AA17	PB40B	4	C	
AB19	PB33A	4	T		AB19	PB41A	4	T		AB19	PB41A	4	T	
GND	-	-			GND	-	-			GND	GND4	4		
AA18	PB33B	4	C		AA18	PB41B	4	C		AA18	PB41B	4	C	
W16	NC	-			W16	NC	-			W16	PB42A	4	T	
U15	NC	-			U15	NC	-			U15	PB42B	4	C	
V16	NC	-			V16	NC	-			V16	PB43A	4	T	
U16	NC	-			U16	NC	-			U16	PB43B	4	C	
Y17	NC	-			Y17	NC	-			Y17	PB44A	4	T	
V17	NC	-			V17	NC	-			V17	PB44B	4	C	
AB20	NC	-			AB20	NC	-			AB20	PB45A	4	T	
GND	-	-			GND	-	-			GND	GND4	4		
AA19	NC	-			AA19	NC	-			AA19	PB45B	4	C	
Y16	NC	-			Y16	NC	-			Y16	PB46A	4	T	BDQS46

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
W20	PR48B	3	C	VREF2_3	W20	PR68B	3	C	VREF2_3
Y20	PR48A	3	T	VREF1_3	Y20	PR68A	3	T	VREF1_3
GND	-	-			GND	GND3	3		
GND	-	-			GND	GND3	3		
AA21	PR47B	3	C		AA21	PR59B	3	C	
AB21	PR47A	3	T		AB21	PR59A	3	T	
W19	PR46B	3	C		W19	PR58B	3	C	
V19	PR46A	3	T		V19	PR58A	3	T	
Y21	PR45B	3	C		Y21	PR57B	3	C	
AA22	PR45A	3	T	RDQS45	AA22	PR57A	3	T	RDQS57
V20	PR44B	3	C	RLM0_PLLC_IN_A	V20	PR56B	3	C	RLM0_PLLC_IN_A
GND	GND3	3			GND	GND3	3		
U20	PR44A	3	T	RLM0_PLLT_IN_A	U20	PR56A	3	T	RLM0_PLLT_IN_A
W21	PR43B	3	C	RLM0_PLLC_FB_A	W21	PR55B	3	C	RLM0_PLLC_FB_A
Y22	PR43A	3	T	RLM0_PLLT_FB_A	Y22	PR55A	3	T	RLM0_PLLT_FB_A
V21	PR42B	3	C	DI/CSSPIN	V21	PR54B	3	C	DI/CSSPIN
W22	PR42A	3	T	DOUT/CSON	W22	PR54A	3	T	DOUT/CSON
U21	PR41B	3	C	BUSY/SISPI	U21	PR53B	3	C	BUSY/SISPI
V22	PR41A	3	T	D7/SPID0	V22	PR53A	3	T	D7/SPID0
T19	CFG2	3			T19	CFG2	3		
U19	CFG1	3			U19	CFG1	3		
U18	CFG0	3			U18	CFG0	3		
V18	PROGRAMN	3			V18	PROGRAMN	3		
T20	CCLK	3			T20	CCLK	3		
T21	INITN	3			T21	INITN	3		
R20	DONE	3			R20	DONE	3		
GND	GND3	3			GND	GND3	3		
T18	PR37B	3	C		T18	PR49B	3	C	
R17	PR37A	3	T		R17	PR49A	3	T	
R19	PR36B	3	C		R19	PR48B	3	C	
R18	PR36A	3	T	RDQS36	R18	PR48A	3	T	RDQS48
U22	PR35B	3	C		U22	PR47B	3	C	
GND	GND3	3			GND	GND3	3		
T22	PR35A	3	T		T22	PR47A	3	T	
R21	PR34B	3	C		R21	PR46B	3	C	
R22	PR34A	3	T		R22	PR46A	3	T	
P20	PR33B	3	C		P20	PR45B	3	C	
N20	PR33A	3	T		N20	PR45A	3	T	
P19	PR32B	3	C		P19	PR44B	3	C	
P18	PR32A	3	T		P18	PR44A	3	T	
P21	PR31B	3	C		P21	PR43B	3	C	
GND	GND3	3			GND	GND3	3		
P22	PR31A	3	T		P22	PR43A	3	T	
N21	PR30B	3	C		N21	PR42B	3	C	

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFEC20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A21	PT51A	1	T		A21	PT51A	1	T	
E17	PT50B	1	C		E17	PT50B	1	C	
B17	PT50A	1	T		B17	PT50A	1	T	
C17	PT49B	1	C		C17	PT49B	1	C	
GND	GND1	1			GND	GND1	1		
D17	PT49A	1	T		D17	PT49A	1	T	
F17	PT48B	1	C		F17	PT48B	1	C	
E20	PT48A	1	T		E20	PT48A	1	T	
G17	PT47B	1	C		G17	PT47B	1	C	
B20	PT47A	1	T		B20	PT47A	1	T	
E16	PT46B	1	C		E16	PT46B	1	C	
A20	PT46A	1	T	TDQS46	A20	PT46A	1	T	TDQS46
A19	PT45B	1	C		A19	PT45B	1	C	
GND	GND1	1			GND	GND1	1		
B19	PT45A	1	T		B19	PT45A	1	T	
D16	PT44B	1	C		D16	PT44B	1	C	
C16	PT44A	1	T		C16	PT44A	1	T	
F16	PT43B	1	C		F16	PT43B	1	C	
A18	PT43A	1	T		A18	PT43A	1	T	
G16	PT42B	1	C		G16	PT42B	1	C	
B18	PT42A	1	T		B18	PT42A	1	T	
A17	PT41B	1	C		A17	PT41B	1	C	
GND	GND1	1			GND	GND1	1		
A16	PT41A	1	T		A16	PT41A	1	T	
D15	PT40B	1	C		D15	PT40B	1	C	
B16	PT40A	1	T		B16	PT40A	1	T	
E15	PT39B	1	C		E15	PT39B	1	C	
C15	PT39A	1	T		C15	PT39A	1	T	
F15	PT38B	1	C		F15	PT38B	1	C	
G15	PT38A	1	T	TDQS38	G15	PT38A	1	T	TDQS38
B15	PT37B	1	C		B15	PT37B	1	C	
GND	GND1	1			GND	GND1	1		
A15	PT37A	1	T		A15	PT37A	1	T	
E14	PT36B	1	C		E14	PT36B	1	C	
G14	PT36A	1	T		G14	PT36A	1	T	
D14	PT35B	1	C	VREF2_1	D14	PT35B	1	C	VREF2_1
E13	PT35A	1	T	VREF1_1	E13	PT35A	1	T	VREF1_1
F14	PT34B	1	C		F14	PT34B	1	C	
C14	PT34A	1	T		C14	PT34A	1	T	
B14	PT33B	0	C	PCLKC0_0	B14	PT33B	0	C	PCLKC0_0
GND	GND0	0			GND	GND0	0		
A14	PT33A	0	T	PCLKT0_0	A14	PT33A	0	T	PCLKT0_0

LatticeECP Industrial (Continued)

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP20E-3FN672I	400	-3	Lead-Free fpBGA	672	IND	19.7K
LFCEP20E-4FN672I	400	-4	Lead-Free fpBGA	672	IND	19.7K
LFCEP20E-3FN484I	400	-3	Lead-Free fpBGA	484	IND	19.7K
LFCEP20E-4FN484I	400	-4	Lead-Free fpBGA	484	IND	19.7K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFCEP33E-3FN672I	496	-3	Lead-Free fpBGA	672	IND	32.8K
LFCEP33E-4FN672I	496	-4	Lead-Free fpBGA	672	IND	32.8K
LFCEP33E-3FN484I	360	-3	Lead-Free fpBGA	484	IND	32.8K
LFCEP33E-4FN484I	360	-4	Lead-Free fpBGA	484	IND	32.8K